| Electronic Patent Application Fee Transmittal | | | | | | | |
|---|---|----------|----------|--------|-------------------------|--|--|
| Application Number: | 10810965 | | | | | | |
| Filing Date: | 26-Mar-2004 | | | | | | |
| Title of Invention: | Novel method to improve bump reliability for flip chip device | | | | | | |
| First Named Inventor: | Yen-Ming Chen | | | | | | |
| Filer: | Daniel R. McClure | | | | | | |
| Attorney Docket Number: | TS01-0413C | | | | | | |
| Filed as Large Entity | | | | | | | |
| Utility Filing Fees | | | | | | | |
| Description | | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | |
| Basic Filing: | | | | | | | |
| Pages: | | | | | | | |
| Claims: | | | | | | | |
| Miscellaneous-Filing: | | | | | | | |
| Petition: | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | |
| Notice of appeal | | 1401 | 1 | 500 | 500 | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | |
| Extension-of-Time: | | | | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|-----------------------------------|----------|----------|--------|-------------------------|
| Extension - 1 month with \$0 paid | 1251 | 1 | 120 | 120 |
| Miscellaneous: | | | | |
| | Tota | 620 | | |